

Small Signal Diode



Features

- ✧ Flat Lead SOD-323F small outline plastic package
- ✧ Surface device type mounting
- ✧ Moisture sensitivity level 1
- ✧ Matte Tin(Sn) lead finish with Nickel(Ni) underplate
- ✧ Pb free version and RoHS compliant
- ✧ Green compound (Halogen free) with suffix "G" on packing code and prefix "G" on date code

Mechanical Data

- ✧ Case : Flat lead SOD-323F small outline plastic package
- ✧ Terminal: Matte tin plated, solderable per MIL-STD-202, Method 208 guaranteed
- ✧ High temperature soldering guaranteed: 260°C/10s
- ✧ Polarity : Indicated by cathode band
- ✧ Weight : 4.5±0.5 mg
- ✧ Marking Code : S5, S6, S7

Ordering Information

Part No.	Package	Packing Code	Packing	Marking
BAV19WS	SOD-323F	RR	3K / 7" Reel	S5
BAV20WS	SOD-323F	RR	3K / 7" Reel	S6
BAV21WS	SOD-323F	RR	3K / 7" Reel	S7
BAV19WS	SOD-323F	RRG	3K / 7" Reel	S5
BAV20WS	SOD-323F	RRG	3K / 7" Reel	S6
BAV21WS	SOD-323F	RRG	3K / 7" Reel	S7

Maximum Ratings and Electrical Characteristics

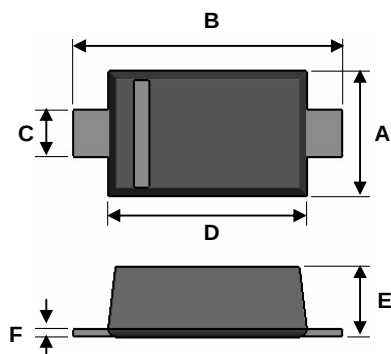
Rating at 25°C ambient temperature unless otherwise specified.

Maximum Ratings

Type Number	Symbol	Value	Units
Power Dissipation	P_D	200	mW
Repetitive Peak Reverse Voltage	V_{RRM}	250	V
Average Rectified Forward Current	$I_{F(AV)}$	200	mA
Non-Repetitive Peak Forward Surge Current	I_{FSM}	2.5	A
Pulse width= 1μs Pulse width= 1s		0.5	
Junction and Storage Temperature Range	T_J, T_{STG}	-65 to + 150	°C

Note1. The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application.

SOD-323F

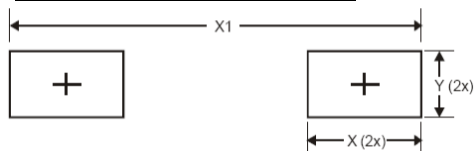


Dimensions (mm)	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	1.15	1.40	0.045	0.055
B	2.30	2.80	0.091	0.110
C	0.25	0.40	0.010	0.016
D	1.60	1.80	0.063	0.071
E	0.80	1.10	0.031	0.043
F	0.05	0.15	0.002	0.006

Pin Configuration



Suggested PAD Layout



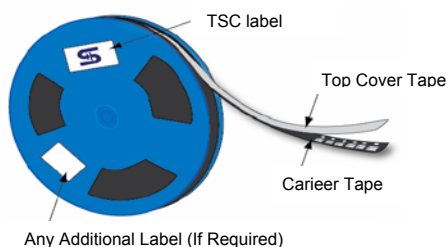
Dimensions	Value (in mm)
X	0.710
X1	2.900
Y	0.403

Small Signal Diode

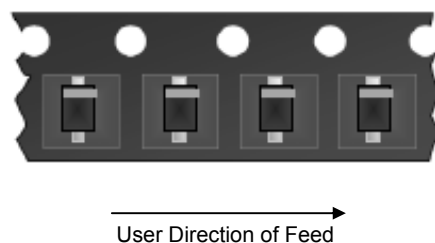
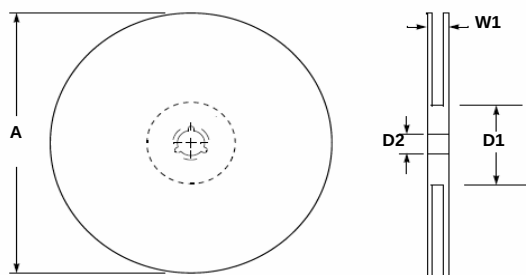
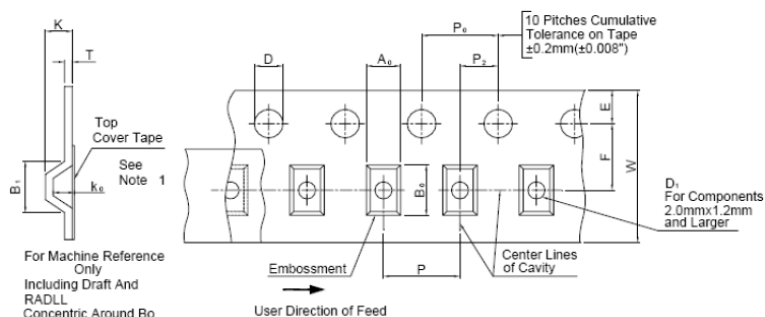
Electrical Characteristics

Type Number		Symbol	Min	Max	Units
Breakdown Voltage	BAV19W	V_R	120	-	V
	BAV20W (Note 2)		200	-	
	BAV21W		250	-	
Forward Voltage	$I_F = 100\text{mA}$	V_F	-	1.00	V
	$I_F = 200\text{mA}$		-	1.25	
Reverse Leakage Current	BAV19W BAV20W (Note 3) BAV21W	I_R	-	100	nA
Junction Capacitance	$V_R=0, f=1.0\text{MHz}$	C_J	-	5.0	pF
Reverse Recovery Time	(Note 4)	T_{rr}	-	50	ns

Tape & Reel specification



Item	Symbol	Dimension(mm)
Carrier depth	K	2.40 Max.
Sprocket hole	D	1.5 ± 0.1
Reel outside diameter	A	178 ± 1
Reel inner diameter	D1	50 Min.
Feed hole width	D2	13.0 ± 0.5
Sprocket hole position	E	1.75 ± 0.10
Punch hole position	F	3.50 ± 0.05
Sprocket hole pitch	P0	4.00 ± 0.10
Embossment center	P1	2.00 ± 0.10
Overall tape thickness	T	0.6 Max.
Tape width	W	8.30 Max.
Reel width	W1	14.4 Max.



Note 2: Test Condition : $I_R=100\mu\text{A}$

Note 3: Test Condition : BAV19WS @ $V_R=100\text{V}$, BAV20WS @ $V_R=150\text{V}$, BAV21WS @ $V_R=200\text{V}$

Note 4: Test Condition : $I_F=I_R=30\text{mA}$, $R_L=100\Omega$, $I_{RR}=3\text{mA}$

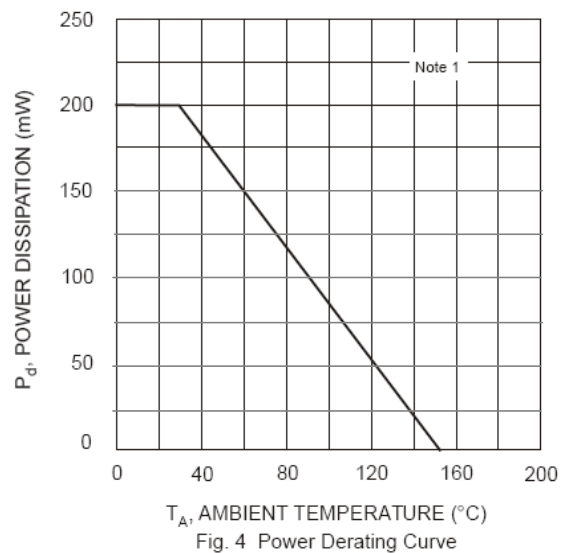
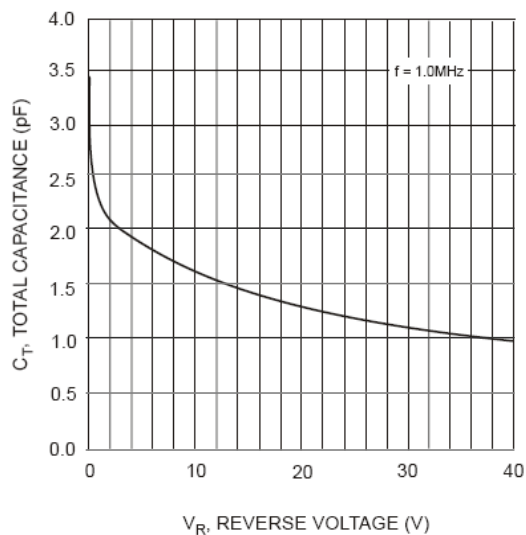
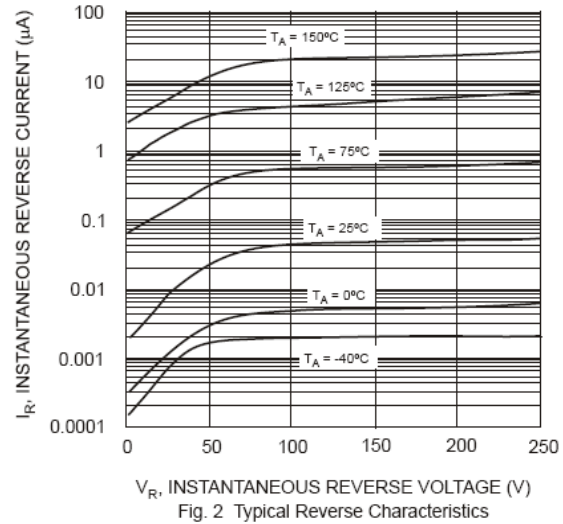
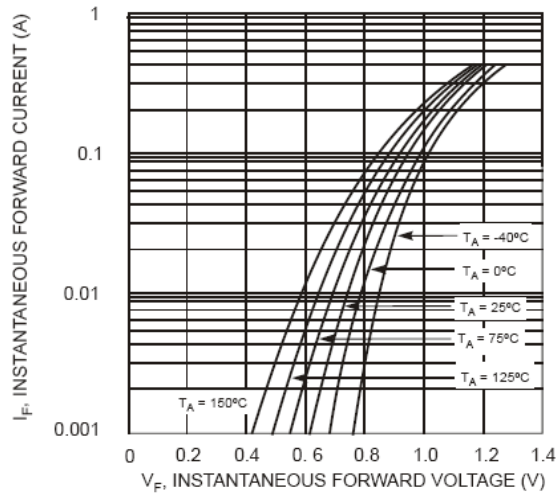
Note 5: A0, B0, and K0 are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min. to 0.5 mm max. The component cannot rotate more than 10° within the determined cavity.

Note 6: If B1 exceeds 4.2 mm(0.165") for 8 mm embossed tape, the tape may not feed through all tape feeders.

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Rating and Characteristic Curves

BAV19WS/BAV20WS/BAV21WS 200mW High Voltage SMD Switching Diode



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